Requirements for the future temporary handling procedure for irradiated electronics

Until the Workshop for the handling or radioactive materials is ready in bld. 867 (end of 2010 or beginning of 2011), a temporary procedure is needed to allow for non-destructive testing of electronics in several approved labs and destructive in one common lab.

If an equipment group would like to keep the possibility of performing any tests on the DUTs after the irradiation in UJ22 or CNGS in 2010, a clear description has to be submitted at least <u>2 weeks</u> <u>BEFORE</u> the start of the irradiation consisting of:

- Description of actions to be performed (i.e. scope measurements, exchange of a subsystem, exchange of irradiated components by new ones etc...)
 - \circ $\;$ Destructive actions to be listed separately (soldering)
- Name of the lab where non-destructive tests should be carried out
 - \circ $\,$ Destructive tests would have to be performed most likely in 530 $\,$
- Responsible person for the tests
- Justification (importance for the LHC)

The procedure will have to be approved by DGS/RP (Doris), the RSO and the responsible of the lab. The number of approved labs has to be kept to a strict minimum! The present list is (EDMS <u>1056444</u>):

- 36-3-017 (CRYO)
- 866-1D-001 (BPM)
- 287 (TE/EPC lab)
- 30-5/040 (BIC/PIC)

Description of the test setup has to be done in the document <u>IRRADIATION PLANNING</u> (next page) prior to installation

CNGS electronics test irradiation LOG						
INTERVENTION						
Date:			Time:			
Location of the test equipment						Group
People requiring						
access to TSG4						
	naterial (<u>attach photo</u>) and responsible					
Owner, group:					Tel:	
Size:					Weight:	
Details:						
Irradiation planning (targeted dose, fluence etc)						
Post-Irradiation Handling						
Removal from T date:	SG4 tunnel -					
Removal from C - date:		Peak dos rate			se	
					Tato	
Comments:						
DGS/RP COMMENTS						
RP agent:				Date:		